

**TRANSMITTAL OF FORMAL DRAWINGS**Docket No.  
FIS919970163US4In Re Application Of: **Ronald J. Bolam, et al.**

Serial No.	Filing Date	Batch No.	Examiner	Art Unit
09/878,681	06/11/2001		Fetsum Abraham	2826

Invention: **Silicon-on-Insulator Chip Having an Isolation Barrier for Reliability**Address to:  
Assistant Commissioner for Patents  
Washington, D.C. 20231

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Transmitted herewith are:

16 sheets of formal drawing(s) for this application.

Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c)  
on the reverse side of the drawing.

Dated: 8-3-02

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I certify that this document and attached formal drawings  
are being deposited on with the U.S.  
Postal Service as first class mail under 37 C.F.R. 1.8 and  
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